L Number	Hits	Search Text	DB	Time stamp
1	463	204/273.ccls.	USPAT;	2004/09/22 13:45
			US-PGPUB;	
			EPO; JPO;	
			DERWENT	
2	26	204/273.ccls. AND wafer	USPAT;	2004/09/22 13:48
			US-PGPUB;	
			EPO; JPO;	
			DERWENT	
5	10	204/273.ccls. AND stir\$4 AND wafer	USPAT;	2004/09/22 13:49
			US-PGPUB;	
			EPO; JPO;	
			DERWENT	-
3	69	204/273.ccls. AND stir\$4	USPAT;	2004/09/22 14:38
		•	US-PGPUB:	
			EPO; JPO;	
			DERWENT	
6	4	US-0628058-\$.DID. OR US-0628058-\$.DID. OR	USPAT;	2004/09/22 13:57
		US-0625125-\$.DID. OR US-6099712-\$.DID.	US-PGPUB:	
			EPO; JPO;	
			DERWENT	
7	2	US-0628058-\$.DID. OR US-0628058-\$.DID. OR	USPAT;	2004/09/22 13:57
,		US-0625125-\$.DID. OR US-6099712-\$.DID. AND stir\$4	US-PGPUB;	
			EPO; JPO;	
			DERWENT	
8	61	205/148.ccls. and stir\$4	USPAT;	2004/09/22 15:46
			US-PGPUB;	
			EPO; JPO;	
			DERWENT	
9 ·	18	204/261.ccls. and stir\$4	USPAT:	2004/09/22 15:54
		,	US-PGPUB;	
			EPO; JPO;	
			DERWENT	
10	0	204/\$ccls. and stir\$4 AND wafer	USPAT;	2004/09/22 15:55
			US-PGPUB;	
			EPO; JPO;	
			DERWENT	